GlobalSIP 2013

IEEE Global Conference on Signal and Information Processing

Mobile Imaging

www.ieeeglobalsip.org/sym/13/MI

December 3-5, 2013 • Austin, Texas, U.S.A.

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Call for Papers

The integration of cameras and general-purpose processors in mobile devices such as smartphones and tablets, has opened up a wide range of new opportunities for creating visually enriched applications. Mobile imaging, which covers all aspects of imaging on mobile devices from image formation (with potential new camera designs such as multi-aperture systems to accommodate small form factors) to processing (by exploring the available online content and other input data such as location and interactive gestures), present great new opportunities for innovation by the signal and information processing community. This symposium aims to bring researchers from academia and industry to discuss and present new tools, innovative ideas, and applications in the rapidly growing area of mobile imaging.

Topics of interest include:

- Multimedia processing on mobile devices
- Mobile computational photography
- Augmented reality
- Image enhancement for mobile devices
- Mobile visual search
- Mobile imaging system design
- Mobile image quality
- User experience and interaction on mobile devices

Paper Submission

Paper submission will be online only through the GlobalSIP 2013 website. Papers should be in IEEE two-column format and no longer than 4 pages.

Symposia Website

Full details, new updates, and submission instructions can be found on the symposia website, http://www.ieeeglobalsip.org/sym/13/MI

Important Dates

Paper Submission Deadline	June 15, 2013
Review Results Announce	July 30, 2013
Camera-Ready Papers Due	September 7, 2013



